

U.S. Patent Application Serial No. 09/805,559
Amendment dated July 31, 2003
Reply to the Office Action of March 4, 2003

REMARKS

Claim 6 remains pending in the present application and has been amended. The applicants respectfully submit that no new matter has been added. It is believed that this Amendment is fully responsive to the Office Action dated **March 4, 2003**.

35 U.S.C. §112, First Paragraph Rejection:

Claim 6 is rejected under 35 U.S.C. 112, first paragraph, as containing subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention.

This rejection is respectfully traversed.

The Examiner asserts that the phrase "each of the pads per se having a concave surface" set forth in claim 6 is not supported by the originally filed specification and therefore is new matter.

However, such language has been deleted from claim 6. In replace thereof claim 6 has been amended to instead recite "a deformed surface" with support being provided in lines 9 - 12, page 9 of the original specification.

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Accordingly, withdrawal of this rejection is respectfully requested.

As to the Merits:

As to the merits of this case, the Examiner relies on the newly cited references of Duboz, et al. (U.S. Patent No. 5,726,500) and Hosomi, et al. (U.S. Patent No. 5,747,881) in setting forth the following rejection:

claim 6 stands rejected under 35 U.S.C. §103(a) as being unpatentable over Hosomi in view of Duboz.

This rejection is respectfully traversed.

The Examiner relies on Fig. 20 of Hosomi for teaching a bump 6, having a smaller diameter portion, insulation film 3 and pad 2, and Fig. 5 of Duboz for teaching a pad 58 having a concave or deformed surface.

However, neither Hosomi nor Duboz disclose or fairly suggest that the insulating adhesive is in contact with each of the pads and the bumps. That is, insulation film 3 of Hosomi is not in contact with bump 6. Further, Duboz is silent with regard to this feature.

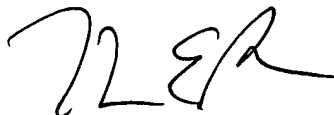
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If, for any reason, it is felt that this application is not now in condition for allowance, the Examiner is requested to contact Applicants undersigned attorney at the telephone number indicated below to arrange for an interview to expedite the disposition of this case.

In the event that this paper is not timely filed, Applicants respectfully petition for an appropriate extension of time. Please charge any fees for such an extension of time and any other fees which may be due with respect to this paper, to Deposit Account No. 01-2340.

Respectfully submitted,

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